

April 1994 Revised February 2005

74VHC4066 Quad Analog Switch

General Description

These devices are digitally controlled analog switches utilizing advanced silicon-gate CMOS technology. These switches have low "on" resistance and low "off" leakages. They are bidirectional switches, thus any analog input may be used as an output and visa-versa. Also the 4066 switches contain linearization circuitry which lowers the "on" resistance and increases switch linearity. The 4066 devices allow control of up to 12V (peak) analog signals with digital control signals of the same range. Each switch has its own control input which disables each switch when low. All analog inputs and outputs and digital inputs are protected from electrostatic damage by diodes to V_{CC} and ground.

Features

- Typical switch enable time: 15 ns
- Wide analog input voltage range: 0–12V
- Low "on" resistance: 30 typ. ('4066)
- Low quiescent current: 80 µA maximum (74VHC)
- Matched switch characteristics
- Individual switch controls
- Pin and function compatible with the 74HC4066

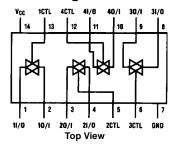
Ordering Code:

Order Number	Package	Package Description			
	Number				
74VHC4066M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow			
74VHC4066MX_NL (Note 1)	M14A	Pb-Free 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow			
74VHC4066MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			
74VHC4066MTCX_NL (Note 1)	MTC14	Pb-Free 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide			
74VHC4066N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide			

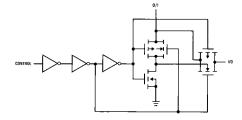
Surface mount packages are also available on Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Note 1: "_NL" indicates Pb-Free package (per JEDEC S-STD-020B). Device available in Tape and Reel only.

Connection Diagram



Schematic Diagram



Truth Table

Input	Switch
CTL	I/O-O/I
L	"OFF"
Н	"ON"

Absolute Maximum Ratings(Note 2)

(Note 3)

Supply Voltage (V _{CC})	−0.5 to +15V
DC Control Input Voltage (V _{IN})	-1.5 to $V_{CC} + 1.5V$
DC Switch I/O Voltage (V _{IO})	V_{EE} – 0.5 to V_{CC} + 0.5V
Clamp Diode Current (I _{IK} , I _{OK})	±20 mA
DC Output Current, per pin (I _{OUT})	±25 mA
DC V _{CC} or GND Current, per pin	
(I _{CC})	±50 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C
Power Dissipation (P _D) (Note 4)	600 mW
S.O. Package only	500 mW
Lead Temperature (T _L)	
(Soldering 10 seconds)	260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	12	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T _A)	-40	+85	°C
Input Rise or Fall Times (t_r, t_f)			
V _{CC} = 2.0V		1000	ns
V _{CC} = 4.5V		500	ns
V _{CC} = 9.0V		400	ns

Note 2: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 3: Unless otherwise specified all voltages are referenced to ground.

Note 4: Power Dissipation temperature derating — plastic "N" package: – 12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 5)

Symbol	Boromotor	Conditions	٧	T _A =25°C		T _A =-40 to 85°C	Units
Symbol	Parameter	Conditions	V _{CC}	Тур	Guaranteed Limits		
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	V
	Input Voltage		4.5V		3.15	3.15	V
			9.0V		6.3	5.3	V
			12.0V		8.4	8.4	V
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	V
			9.0V		2.7	2.7	V
			12.0V		3.6	3.6	V
R _{ON}	Maximum "ON" Resistance	$V_{CTL} = V_{IH}$, $I_S = 2.0 \text{ mA}$	4.5V	100	170	200	Ω
	See (Note 6)	$V_{IS} = V_{CC}$ to GND	9.0V	50	85	105	Ω
		(Figure 1)	12.0V	30	70	85	Ω
			2.0V	120	180	215	Ω
		$V_{CTL} = V_{IH}$, $I_S = 2.0 \text{ mA}$	4.5V	50	80	100	Ω
		$V_{IS} = V_{CC}$ or GND	9.0V	35	60	75	Ω
		(Figure 1)	12.0V	20	40	60	Ω
R _{ON}	Maximum "ON" Resistance	$V_{CTL} = V_{IH}$	4.5V	10	15	20	Ω
	Matching	$V_{IS} = V_{CC}$ to GND	9.0V	5	10	15	Ω
			12.0V	5	10	15	Ω
I _{IN}	Maximum Control	V _{IN} = V _{CC} or GND			±0.05	±0.5	μΑ
	Input Current	$V_{CC} = 2 - 6V$					
I _{IZ}	Maximum Switch "OFF"	V _{OS} = V _{CC} or GND	6.0V	10	±60	±600	nA
	Leakage Current	$V_{IS} = GND \text{ or } V_{CC}$	9.0V	15	±80	±800	nA
		V _{CTL} = V _{IL} (Figure 2)	12.0V	20	±100	±1000	nA
I _{IZ}	Maximum Switch "ON"	$V_{IS} = V_{CC}$ to GND	6.0V	10	±40	±150	nA
	Leakage Current	$V_{CTL} = V_{IH}$	9.0V	15	±50	±200	nA
		V _{OS} = OPEN (Figure 3)	12.0V	20	±60	±300	nA
I _{CC}	Maximum Quiescent	V _{IN} = V _{CC} or GND	6.0V		1.0	10	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$	9.0V		2.0	20	μА
			12.0V		4.0	40	μА

Note 5: For a power supply of $5V \pm 10\%$ the worst case on resistance (R_{ON}) occurs for VHC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current occurs for CMOS at the higher voltage and so the 5.5V values should be used.

Note 6: At supply voltages (V_{CC} – GND) approaching 2V the analog switch on resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital only when using these supply voltages.

AC Electrical Characteristics

 $V_{CC} = 2.0V - 6.0V \ V_{EE} = 0V - 12V, \ C_L = 50 \ pF$ (unless otherwise specified)

Symbol	Parameter	Conditions	V _{CC}	T _A =25°C		T _A =-40 to 85°C	Units
	raiailieter		*CC	Тур	Guarar	nteed Limits	UIIIIS
t _{PHL} , t _{PLH}	Maximum Propagation		3.3V	25	30	20	ns
	Delay Switch In to Out		4.5V	5	10	13	ns
			9.0V	4	8	10	ns
			12.0V	3	7	11	ns
t _{PZL} , t _{PZH}	Maximum Switch Turn	$R_L = 1 \text{ k}\Omega$	3.3V	30	58	73	ns
	"ON" Delay		4.5V	12	20	25	ns
			9.0V	6	12	15	ns
			12.0V	5	10	13	ns
t _{PHZ} , t _{PLZ}	Maximum Switch Turn	$R_L = 1 \text{ k}\Omega$	3.3V	60	100	125	ns
	"OFF" Delay		4.5V	25	36	45	ns
			9.0V	20	32	40	ns
			12.0V	15	30	38	
	Minimum Frequency	$R_L = 600\Omega$	4.5V	40			MHz
	Response (Figure 7)	$V_{IS} = 2 V_{PP} \text{ at } (V_{CC}/2)$	9.0V	100			MHz
	$20 \log (V_O/V_I) = -3 dB$	(Note 7)(Note 8)					
	Crosstalk Between	$R_L = 600\Omega$, $F = 1 MHz$					
	any Two Switches	(Note 8)(Note 9)	4.5V	-52			dB
	(Figure 8)		9.0V	-50			dB
	Peak Control to Switch	$R_L = 600\Omega$, $F = 1 \text{ MHz}$	4.5V	100			mV
	Feedthrough Noise	C _L = 50 pF	9.0V	250			mV
	(Figure 9)						
	Switch OFF Signal	$R_L = 600\Omega$, $F = 1 MHz$					
	Feedthrough	V _(CT) V _{IL}					
	Isolation	(Note 8)(Note 9)	4.5V	-42			dB
	(Figure 10)		9.0V	-44			dB
THD	Total Harmonic	$R_L = 10 \text{ k}\Omega, C_L = 50 \text{ pF},$					
	Distortion	F = 1 kHz					
	(Figure 11)	$V_{IS} = 4 V_{PP}$	4.5V	.013			%
		V _{IS} = 8 V _{PP}	9.0V	.008			%
C _{IN}	Maximum Control			5	10	10	pF
	Input Capacitance						
C _{IN}	Maximum Switch			20			pF
	Input Capacitance						
C _{IN}	Maximum Feedthrough	V _{CTL} = GND		0.5			pF
	Capacitance						
C _{PD}	Power Dissipation			15			pF
	Capacitance						

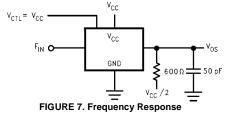
Note 7: Adjust 0 dBm for F = 1 kHz (Null R_L/R_{ON} Attenuation).

Note 8: V_{IS} is centered at $V_{\text{CC}}\!/2.$

Note 9: Adjust input for 0 dBm.

AC Test Circuits and Switching Time Waveforms 1 OF 4 Switches GND FIGURE 1. "ON" Resistance FIGURE 2. "OFF" Channel Leakage Current V_{CTL}= V_{IH} AMMETER CONTROL 1 OF 4 Switches $v_{\text{IS}} = v_{\text{CC}}$ TO GND GND FIGURE 3. "ON" Channel Leakage Current $v_{CTL} = v_{CC}$ CONTROL VCC 1 OF 4 GND V_{OH} V_{DE} Vos FIGURE 4. $t_{\text{PHL}}, t_{\text{PLH}}$ Propagation Delay Time Signal Input to Signal Output tpLZ tezL **t**PLZ CONTROL ¥cc 1 OF 4 O/ SWITCHES GND V15 = 0V t_{PLZ} 10% FIGURE 5. t_{PZL} , t_{PLZ} Propagation Delay Time Control to Signal Output Voo VCC 1 OF 4 SWITCHES GND FIGURE 6. t_{PZH}, t_{PHZ} Propagation Delay Time Control to Signal Output

AC Test Circuits and Switching Time Waveforms (Continued)



Crosstalk and Distortion Test Circuits

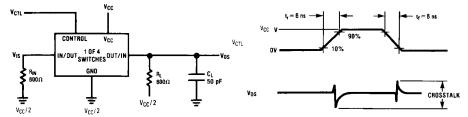


FIGURE 8. Crosstalk: Control Input to Signal Output

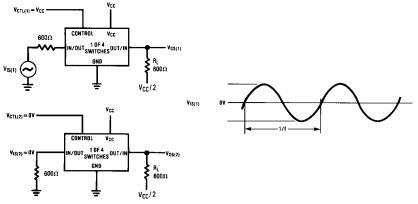


FIGURE 9. Crosstalk Between Any Two Switches

Crosstalk and Distortion Test Circuits (Continued)

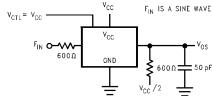


FIGURE 10. Switch OFF Signal Feedthrough Isolation

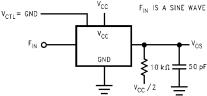
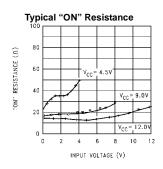
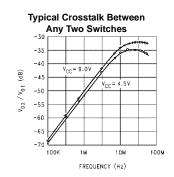
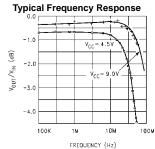


FIGURE 11. Sinewave Distortion

Typical Performance Characteristics

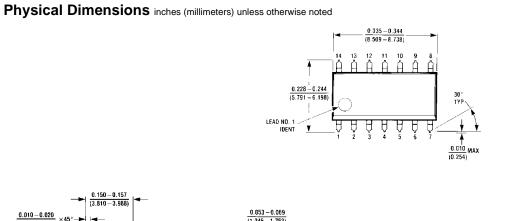


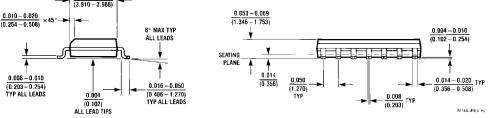




Special Considerations

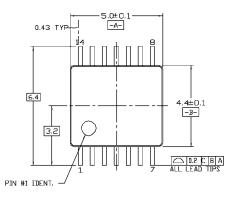
In certain applications the external load-resistor current may include both V_{CC} and signal line components. To avoid drawing V_{CC} current when switch current flows into the analog switch input pins, the voltage drop across the switch must not exceed 0.6V (calculated from the ON Resistance).

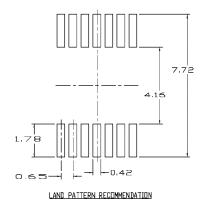


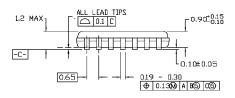


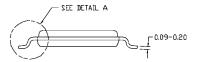
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





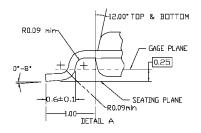




NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB_ REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982

MTC14revD



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 0.740 - 0.770(18.80 - 19.56)0.090 (2.286) 14 13 12 11 10 9 8 14 13 12 0.250 ± 0.010 PIN NO. 1 IDENT PIN NO. 1 IDENT 1 2 3 4 5 6 7 1 2 3 $\frac{0.092}{(2.337)}$ DIA 0.030 MAX (0.762) DEPTH OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ 0.300 - 0.320 $\overline{(7.620 - 8.128)}$ 0.065 $\frac{0.145 - 0.200}{(3.683 - 5.080)}$ 0.060 4° TYP Optional (1.524) (1.651) $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP 0.020 (0.508) 0.125 - 0.150 0.075 ± 0.015 (3.175 - 3.810)0.280 (1.905 ± 0.381) (7.112) MIN 0.014 - 0.0230.100 ± 0.010 (2.540 ± 0.254) TYP (0.356 - 0.584)

14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

 $\frac{0.050\pm0.010}{(1.270-0.254)} \text{ TYP}$

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 $0.325 + 0.040 \\ -0.015 \\ \hline (8.255 + 1.016) \\ -0.381)$

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N144 (REV.E)